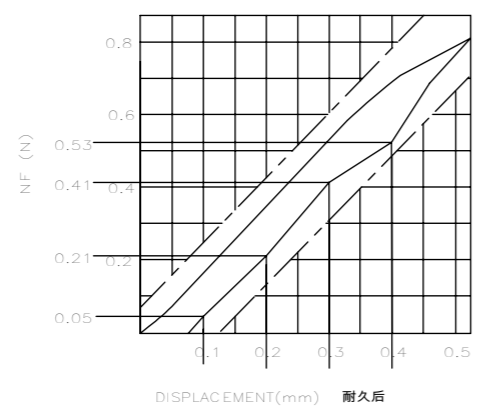
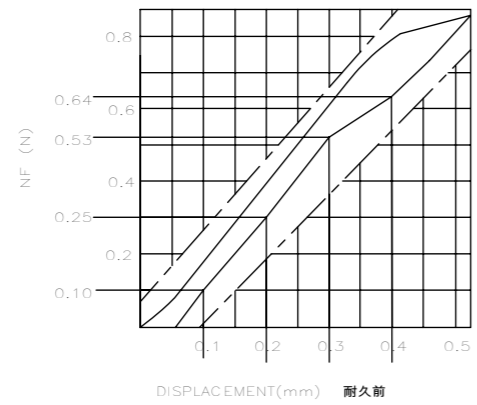


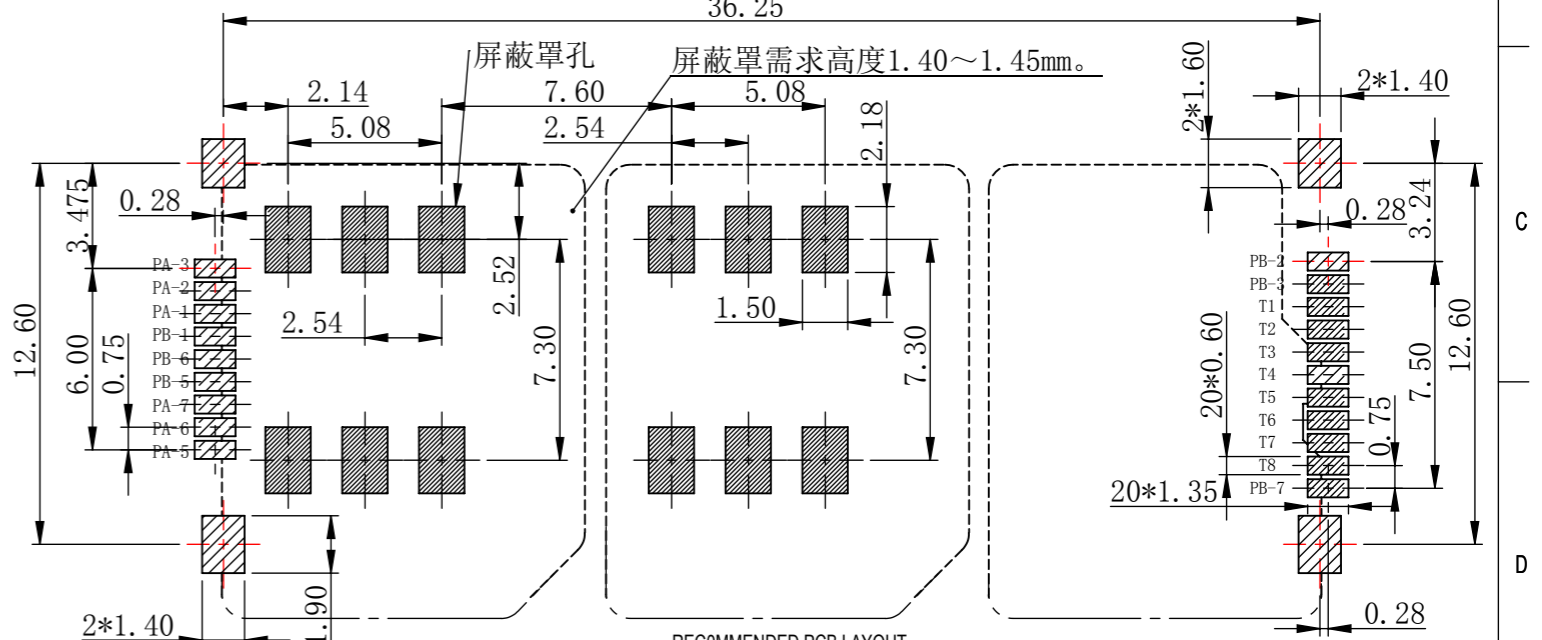
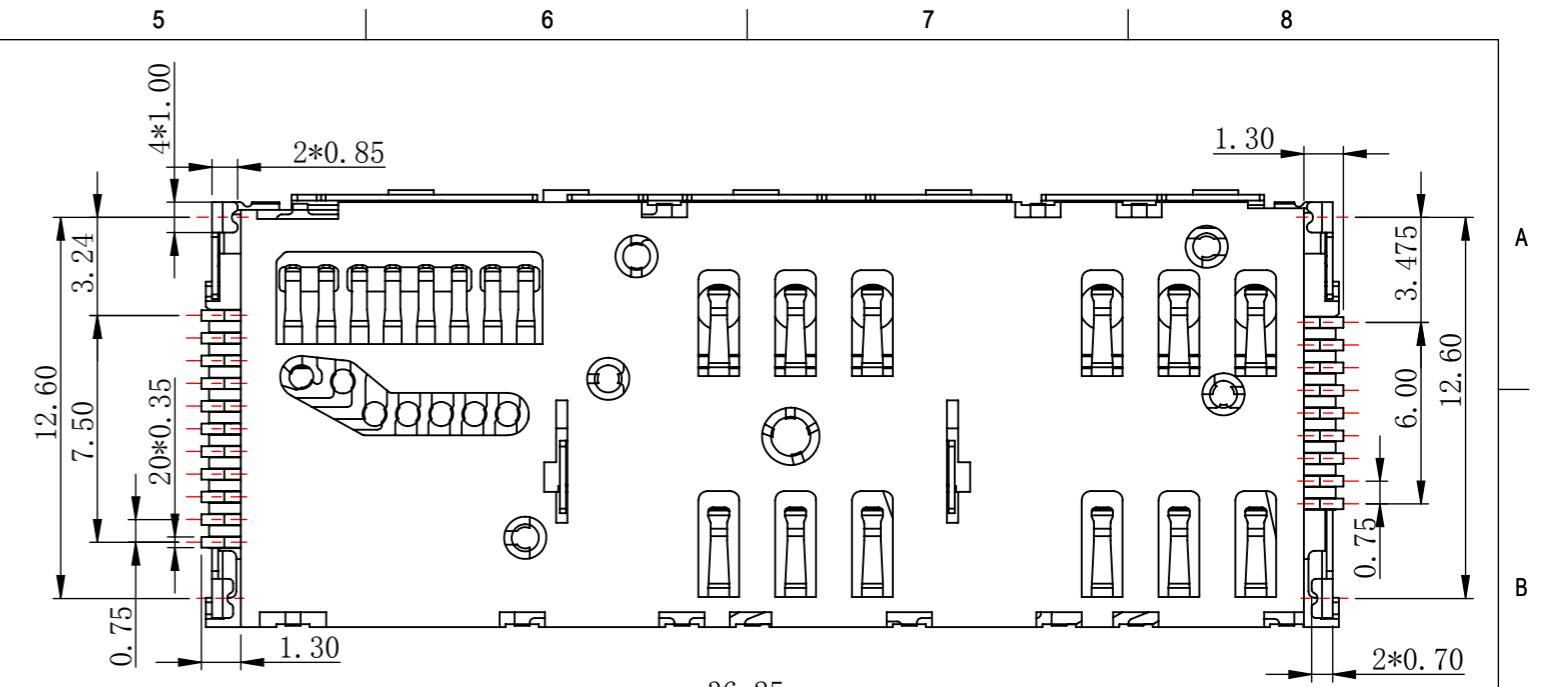
T-CARD PIN NO.	PIN NO.
T1	DAT2
T2	CD/DAT3
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1

SIM CARD PIN NO.	PIN NO.
P1-A/B	VCC
P2-A/B	RST
P3-A/B	CLK
P5-A/B	GND
P6-A/B	VPP
P7-A/B	I/O



- MATERIAL:**  
Housing: LCP, black, ul 94v-0  
Contact: Phosphor Bronze, T=0.15mm  
Shell: SUS, T=0.20mm
- FINISH:**  
CONTACT: 50U" NI MIN UNDER PLATED OVER ALL  
GOLD FLASH 1~3U" ON CONTACT AND SOLDER AREA  
SHELL: 30U" NI MIN UNDER PLATED OVER ALL  
GOLD FLASH 1~3U" ON SOLDER AREA
- GP PASSED ACCORD WITH RoHS STANDARD.
- ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC.
- ALL DIMENSIONS MARKER (XX) MUST BE MEASURED BY FAI.



RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE ± 0.05

- ELECTRICAL MECHANICAL ENVIRONMENT**  
6-1. Dielectric withstanding Voltage : 500V AC 1min.  
6-2. Insulation Resistance: 100 MΩMin.  
6-3. Normal Force 0.1Kg max  
6-4. Insertion Force: 1Kg max  
6-5. Extraction Force: 0.3~1.0Kg  
6-6. Durability: 3000 cycles
- ▽ IS CPK DIMENSIONS.

UNITS: mm	GENERAL TOLERANCE		DRAW:	PART NO: S77-0B20F31A
DATE: 01/23/2016	X. ±0.25	X* ±5.00°	CHECKED:	TITLE: DOUBLE MICRO SIM CARD + T-CARD 板上 3.1H 避空高度1.55H
SCALE: 4/1	.X ±0.15	.X* ±3.00°	APPROVE:	DRAWING NO:
SHEET: 1/1	.XX ±0.10	.XX* ±1.00°		
REV. A	.XXX ±0.05	.XXX* ±0.50°		

